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(12) **United States Design Patent**  
**Zhang**

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(54) **HEADPHONES WITH A DETACHABLE HEADBAND**

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(\*\*) Term: **14 Years**

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(51) **LOC (8) Cl.** ..... **14-01**

(52) **U.S. Cl.** ..... **D14/205**

(58) **Field of Classification Search** ..... D14/205,  
D14/206, 223, 188, 192; 187/129, 130; 379/430,  
379/431; 381/370, 376, 377, 378, 379, 380,  
381/381; 24/303; 63/3, 29.1  
See application file for complete search history.

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LLP

(57) **CLAIM**

The ornamental design for headphones with a detachable headband, as shown and described.

**DESCRIPTION**

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FIG. 1 is a perspective view of headphones with a detachable headband showing my new design, the undisclosed rear of the earphone is not part of the claimed design:

FIG. 2 is a front elevation view of the headphones of FIG. 1;

FIG. 3 is a top plan view of the headphones of FIG. 1;

FIG. 4 is a left side elevation view of the headphones of FIG. 1;

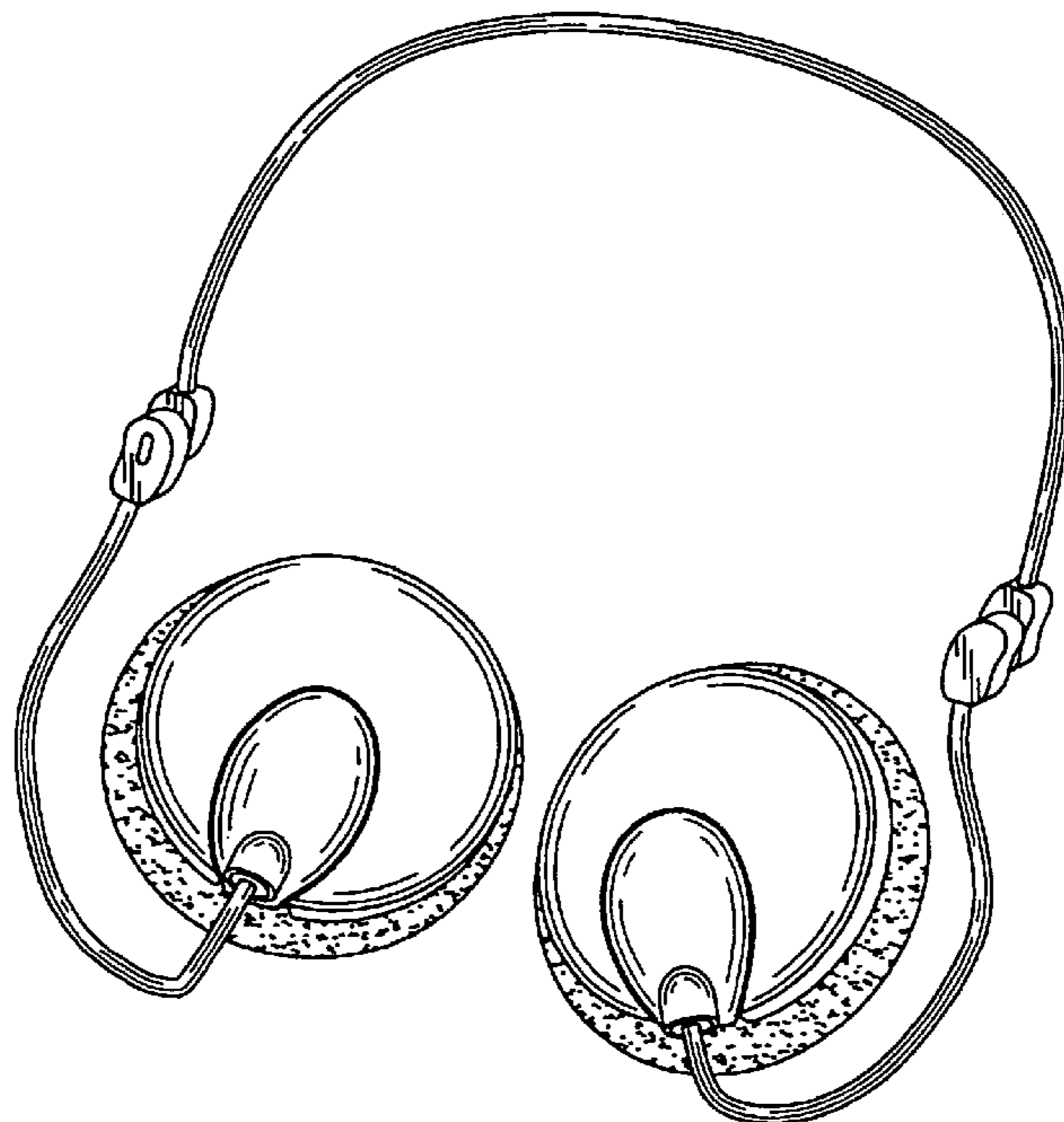
FIG. 5 is a right side elevation view of the headphones of FIG. 1;

FIG. 6 is a rear elevation view of the headphones of FIG. 1;

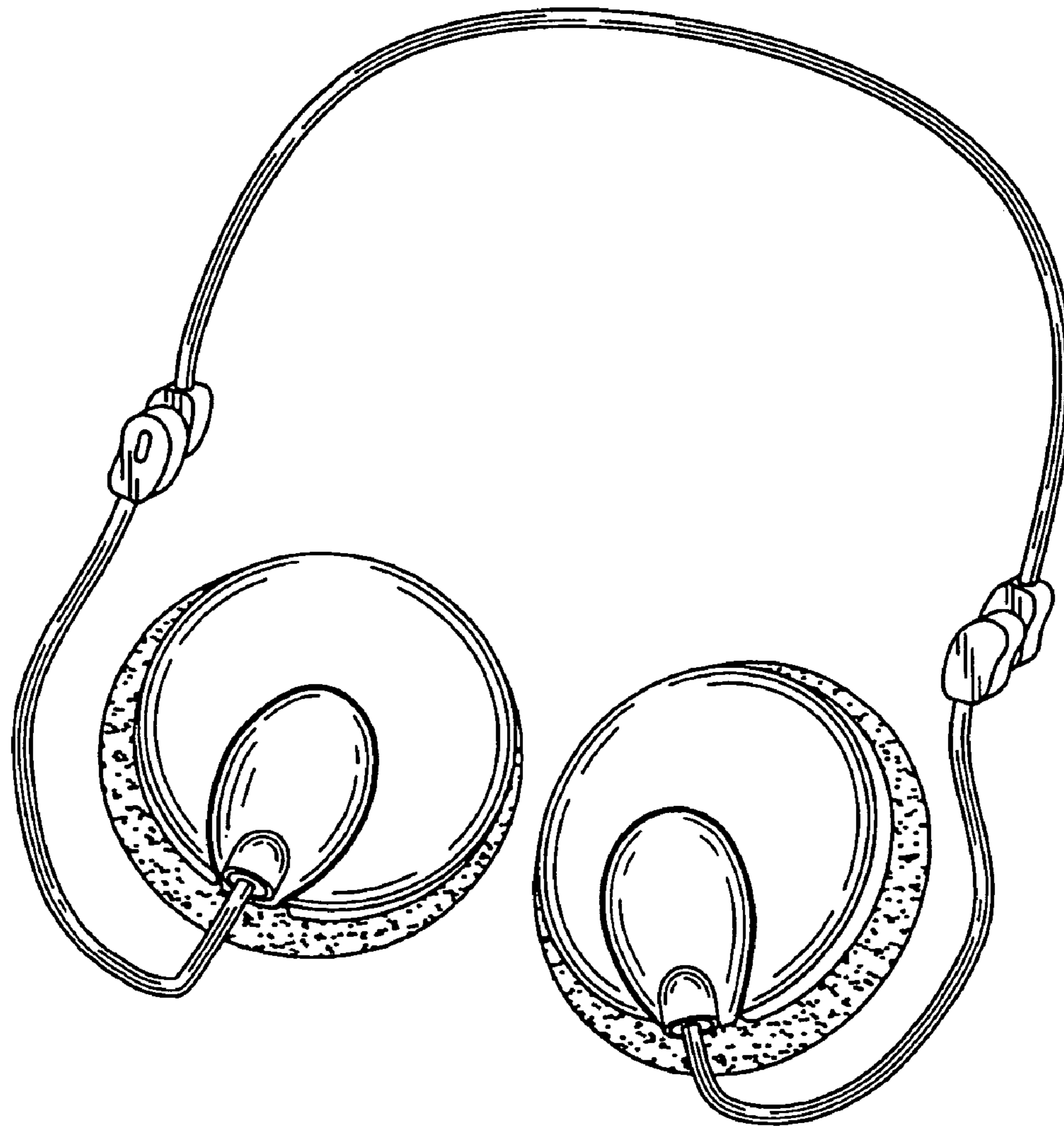
FIG. 7 is a bottom plan view of the headphones of FIG. 1; and,

FIG. 8 is an exploded perspective view of the headphones of FIG. 1.

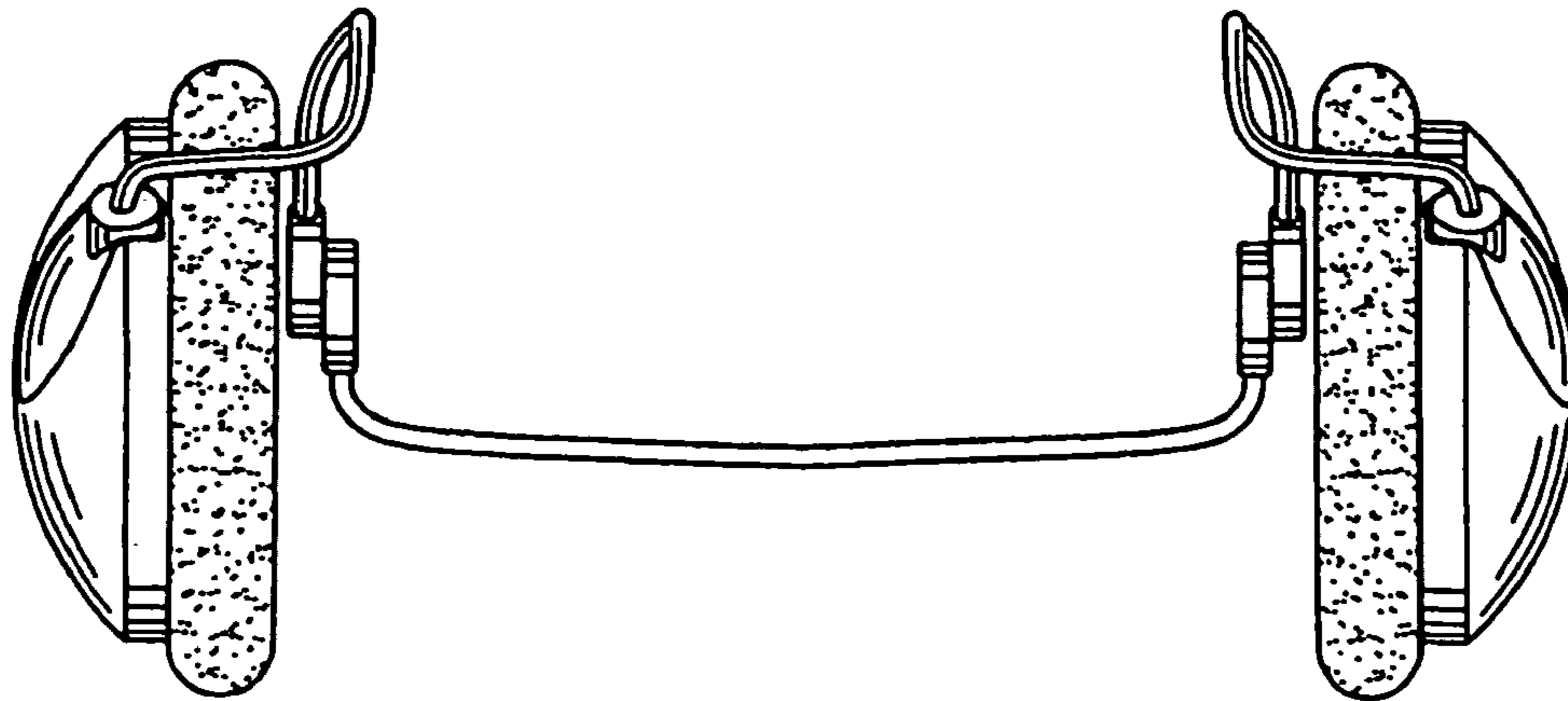
**1 Claim, 5 Drawing Sheets**



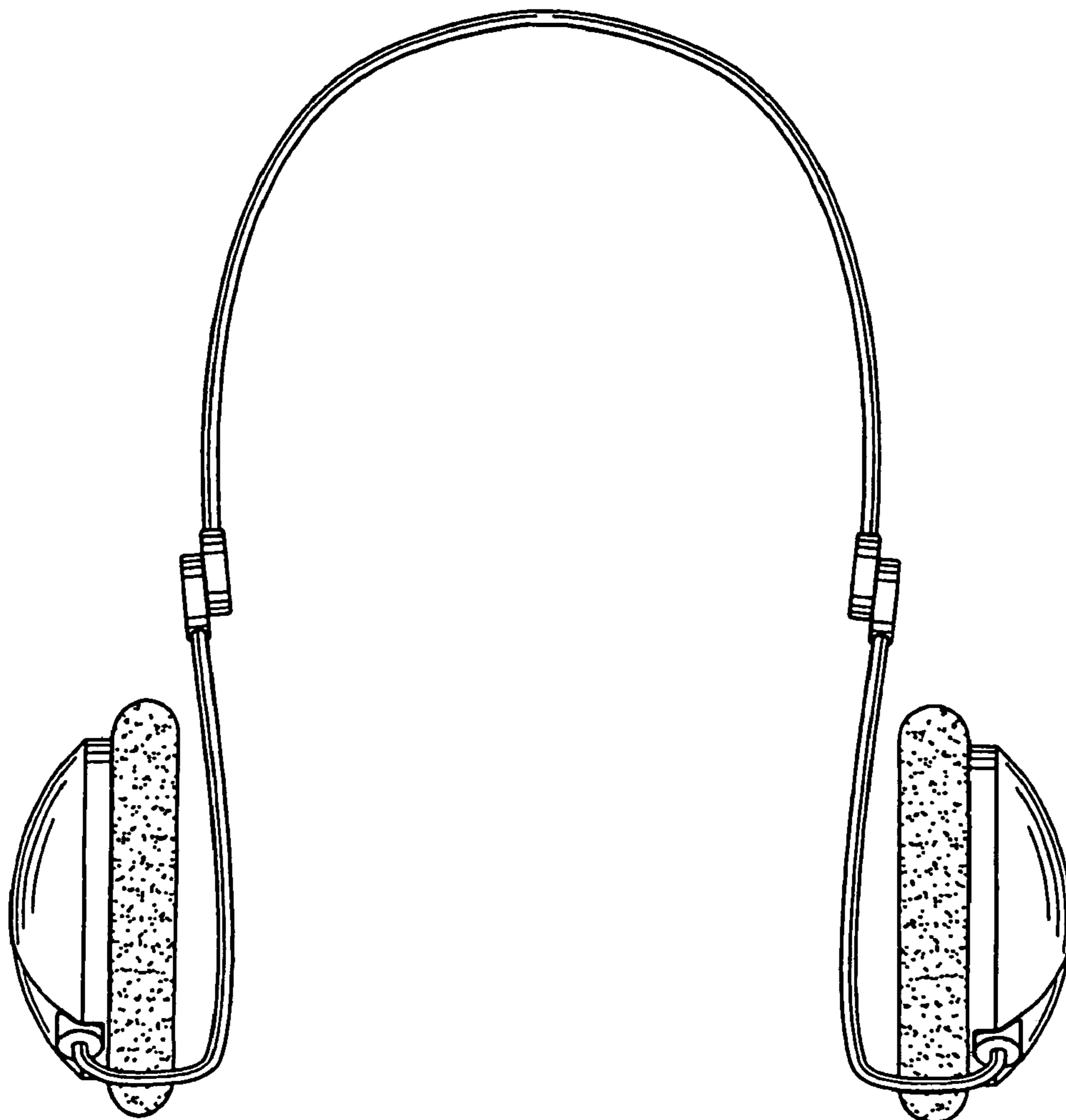
*FIG. 1*



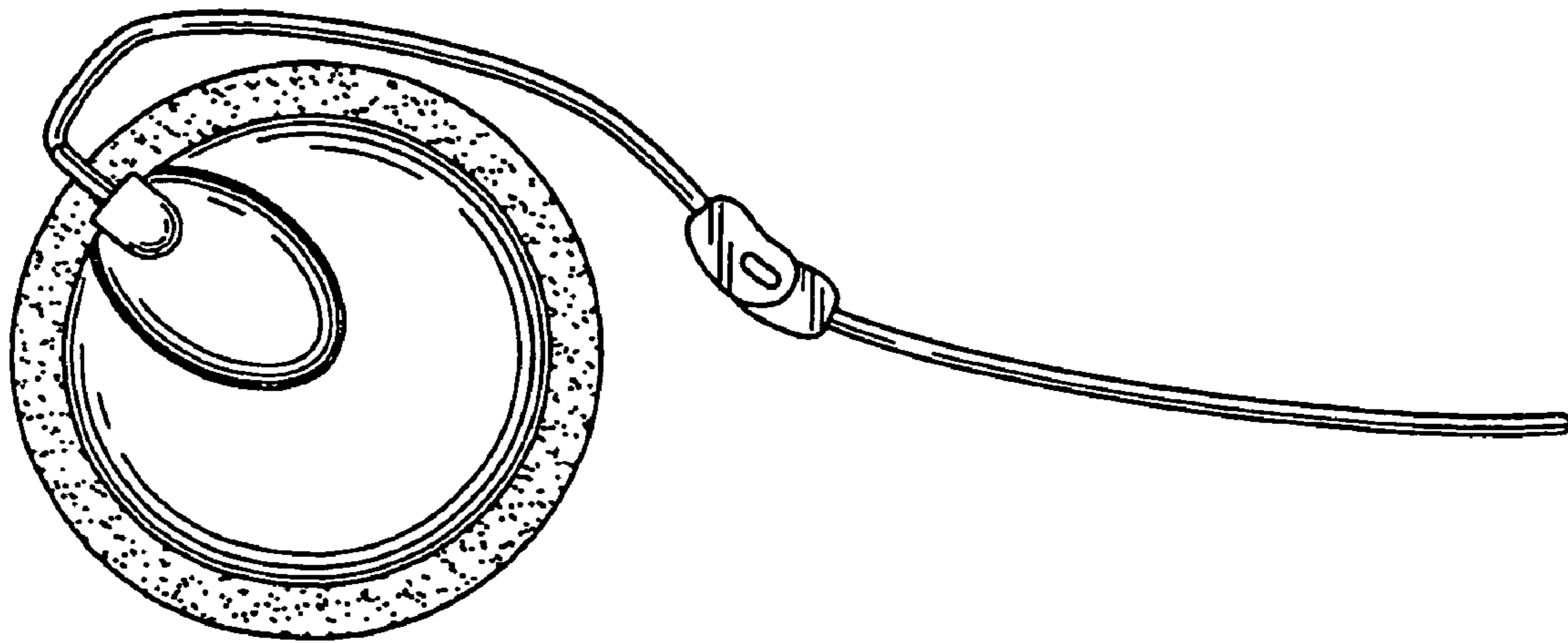
*FIG. 2*



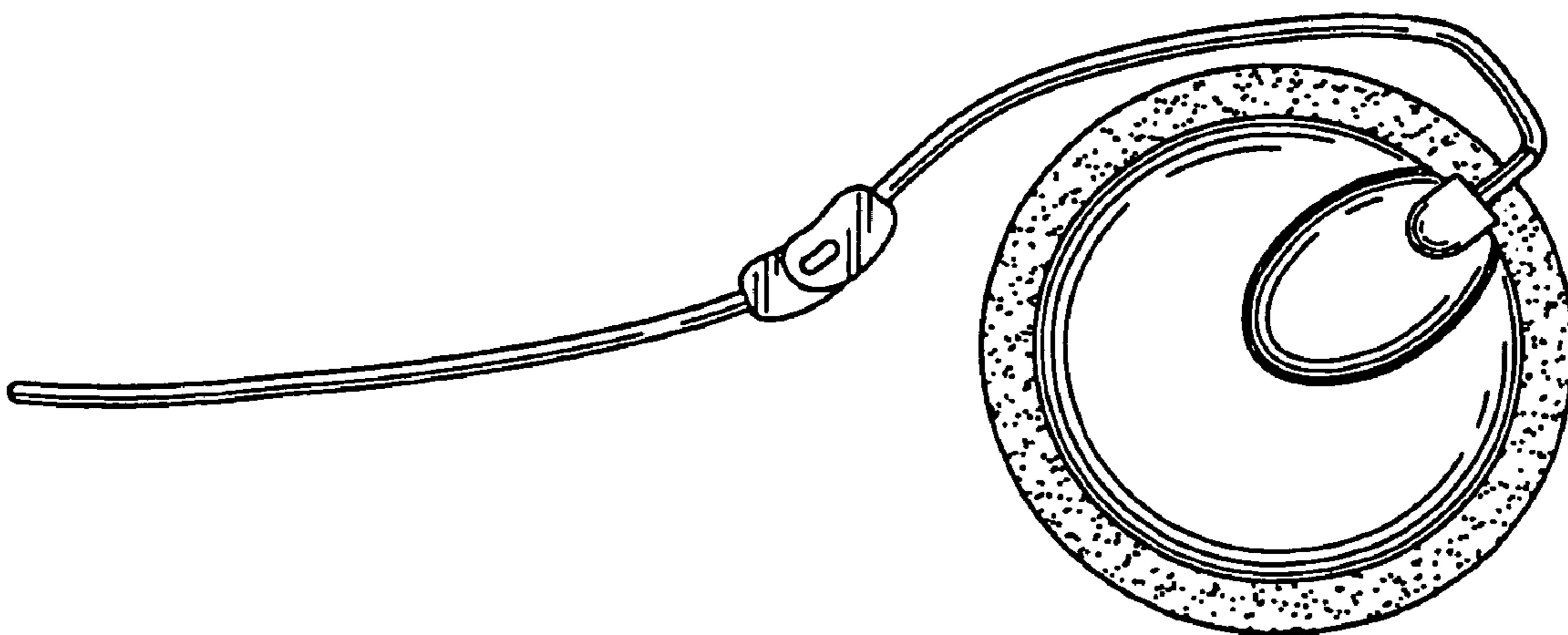
*FIG. 3*



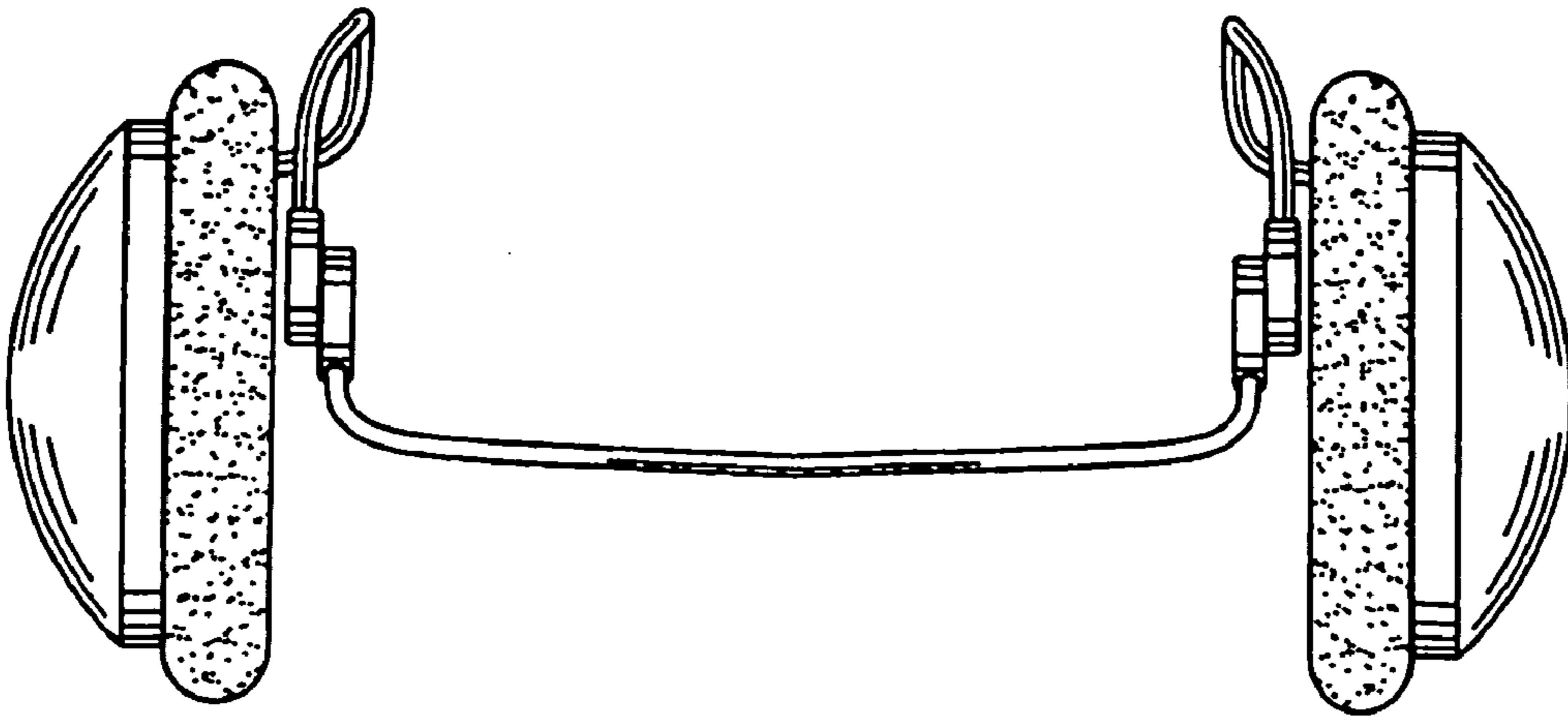
*FIG. 4*



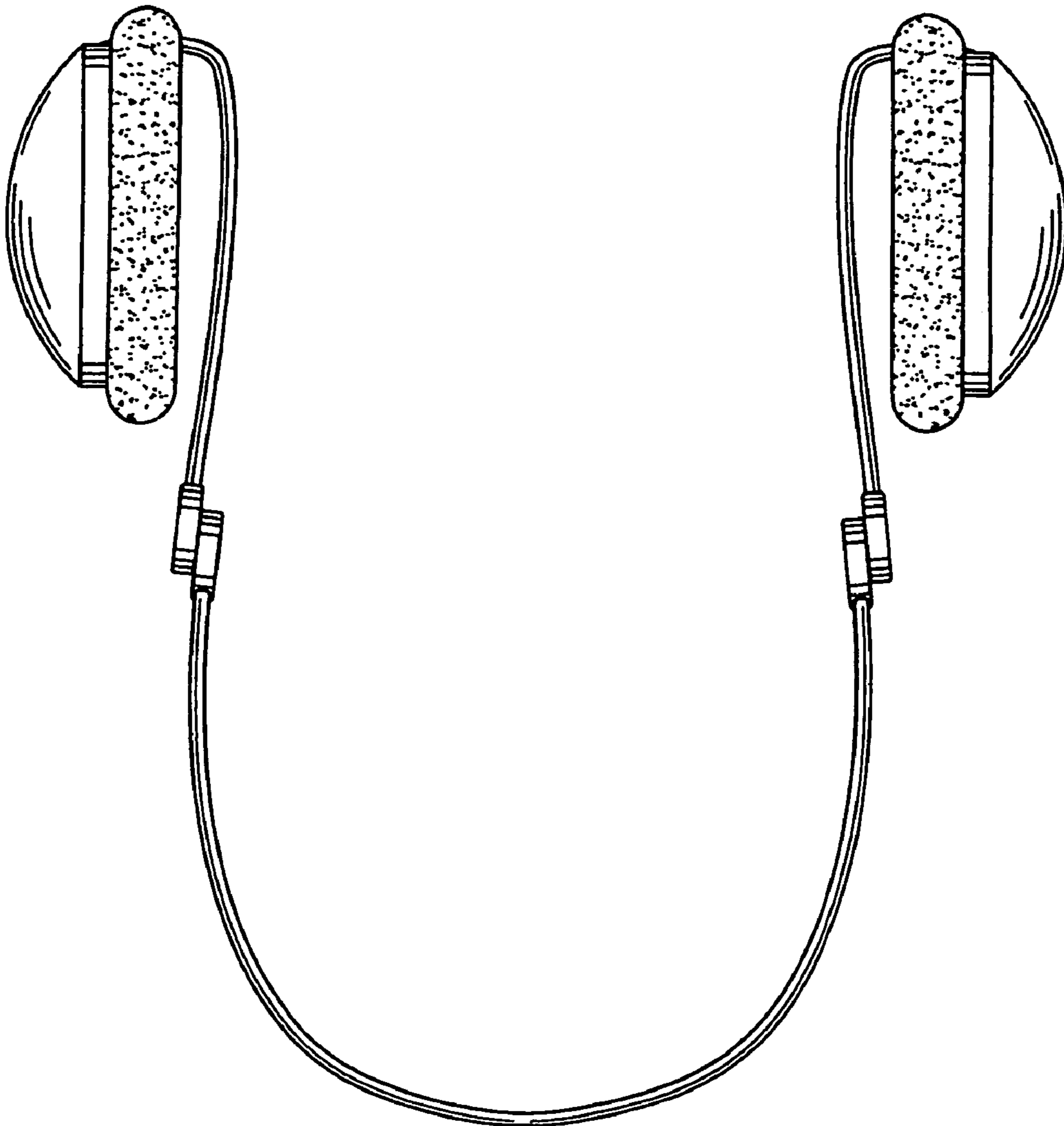
*FIG. 5*



*FIG. 6*



*FIG. 7*



*FIG. 8*

